

## Technical Data

# YZPST-MFC200-16

## THYRISTOR / DIODE MODULE

### Features:

- Heat transfer through aluminium-nitride ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- Thyristor with amplifying gate

### Typical applications:

- DC motor control - AC motor soft starters
- Temperature control
- Professional light dimming

## ELECTRICAL CHARACTERISTICS AND RATINGS

### Reverse blocking - Off-state

Device Type	$V_{RRM}$ (1)	$V_{DRM}$ (1)	$V_{RSM}$ (1)
YZPST MFC200	1600 V	1600 V	1700 V

$V_{RRM}$  = Repetitive peak reverse voltage

$V_{DRM}$  = Repetitive peak off-state voltage

$V_{RSM}$  = Non repetitive peak reverse voltage (2)

Repetitive reverse and off-state peak leakage current	$I_{RRM}, I_{DRM}$	70 mA (3)
Critical rate of rise of off-state voltage	$dv/dt$	1000 V/ $\mu$ s (4)

### Notes:

All ratings are specified for  $T_j = 25^\circ\text{C}$  unless otherwise stated.

(1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to +125 °C.

(2) 10 ms max. pulse width

(3) Maximum value for  $T_j = T_{jmax}$

(4) Min. value for linear and exponential wave shape to 67% rated  $V_{DRM}$ . Gate open.  $T_j = T_{jmax}$

### Conducting

Parameter	Symbol	Min	Max	Typ	Unit	Conditions
Average on-state / forward current	$I_{TAV}, I_{FAV}$		216		A	50 Hz sine wave, 180° conduction, $T_c = 85^\circ\text{C}$
RMS on-state / forward current	$I_{TRMS}, I_{FRMS}$		340		A	50 Hz sine wave, 180° conduction, $T_c = 85^\circ\text{C}$
Surge non repetitive current	$I_{TSM}, I_{FSM}$		6.8		kA	50 Hz sine wave Half cycle
$I^2 t$	$I^2 t$		231		kA²s	$V_R = 0$ $T_j = T_{jmax}$
Peak on-state / forward voltage	$V_{TM}, V_{FM}$		1.1		V	On-state current 200 A, $T_j = T_{jmax}$
Threshold voltage	$V_{T(TO)}$		0.8		V	$T_j = T_{jmax}$
On-state slope resistance	$r_T$		1.4		$\text{m}\Omega$	$T_j = T_{jmax}$
Holding current	$I_H$			150	mA	$T_j = 25^\circ\text{C}$
Latching current	$I_L$			200	mA	$T_j = 25^\circ\text{C}$
Critical rate of rise of on-state current	$di/dt$		500		$\text{A}/\mu\text{s}$	$I_G = 5 I_{GT}$ , $t_r = 1 \mu\text{s}$ , $T_j = T_{jmax}$ , non rep.
RMS isolation voltage	$V_{INS}$		3000		V	AC 50 Hz, 60 s



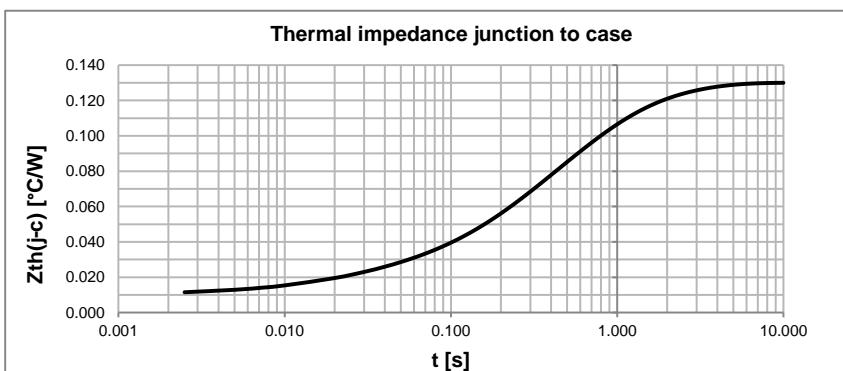
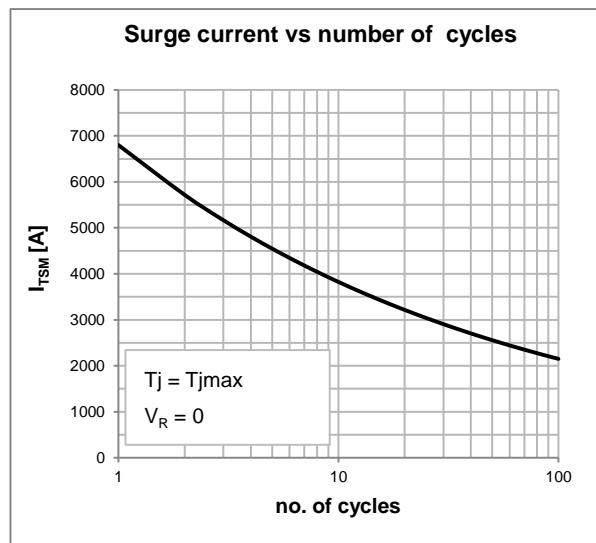
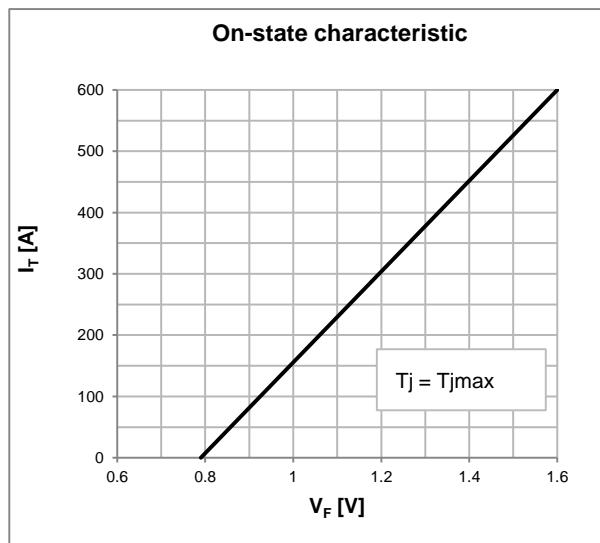
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**THYRISTOR / DIODE MODULE****Triggering**

Parameter	Symbol	Min	Max	Typ	Unit	Conditions
Gate current	$I_{GT}$		150		mA	$V_D = 6 \text{ V}; R_L = 6 \Omega; T_j = 25^\circ\text{C}$
Gate voltage	$V_{GT}$		2		V	$V_D = 6 \text{ V}; R_L = 6 \Omega; T_j = 25^\circ\text{C}$

**Thermal and mechanical characteristics and ratings**

Parameter	Symbol	Min	Max	Typ	Unit	Conditions
Operating temperature	$T_j$	-40	125		°C	
Storage temperature	$T_{stg}$	-40	125		°C	
Thermal resistance junction to case (per arm)	$R_{th(j-c)}$		0.130		°C/W	mounting surfaces smooth, flat and greased
Thermal resistance case to sink (per arm)	$R_{th(c-s)}$		0.050		°C/W	
Mounting torque case-heatsink	$T$	2.3	2.8		N·m	
Mounting torque busbar-terminals	$T$	4.5	5.5		N·m	
Weight	$W$			150	g	



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## OUTLINE AND DIMENSIONS

